RF Transformer

TC8-1

50Ω

2 to 500 MHz

Maximum Ratings

Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA
Permanent damage may occur if any of	f these limits are exceeded.

Pin Connections

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	3
SECONDARY	1
SECONDARY CT	2

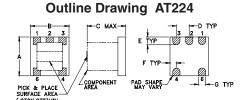
Features

- wideband, 2 to 500 MHz
- · good return loss
- · leadless surface mount
- aqueous washable

CASE STYLE: AT224 PRICE: Contact Sales Dept.

Applications

- · push-pull amplifier
- · impedance matching







Suggested Layout, Tolerance to be within ±.002

Transformer Electrical Specifications

Ω	FREQUENCY		INSERTION LOSS*	
(Secondary/Primary)	(MHz)	3 dB MHz	2 dB MHz	1 dB MHz
8	2-500	2-500	5-400	10-100

^{*} Insertion Loss is referenced to mid-band loss, 0.8 dB typ.

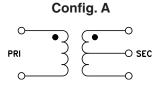
Outline Dimensions (inch mm)

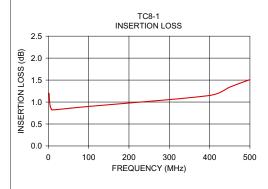
F	E	D	С	В	Α
.025	.030	.050	.150	.150	.150
0.64	0.76	1.27	3.81	3.81	3.81
wt		K	J	Н	G
grams		.030	.190	.065	.028
0.10		0.76	4.83	1.65	0.71

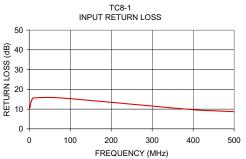
NON-CATALOG

Typical Performance Data

FR	EEQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	
	2.00	1.20	10.65	
	3.00	1.03	12.20	
	5.00	0.90	14.01	
	7.50	0.84	15.09	
	10.00	0.82	15.64	
	55.00	0.86	15.88	
	100.00	0.90	15.29	
	400.00	1.15	9.68	
	450.00	1.34	9.15	
	500.00	1.51	8.67	







Mini-Circuits
ISO 9001 ISO 14001 AS 9100 CERTIFIED

For detailed performance specs

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 The Design Engineers Search Engine

Provides ACTUAL Data Instantly at minicipality.com

IFIRF MICROWAVE COMPONENTS

RF Transformer TC8-1

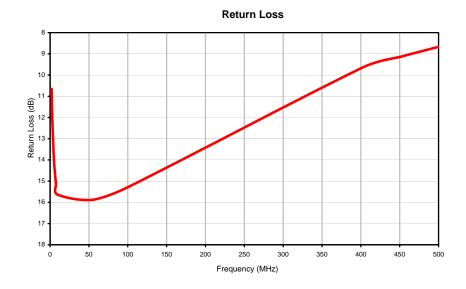
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
2.00	1.20	10.65
3.00	1.03	12.20
5.00	0.90	14.01
7.50	0.84	15.09
10.00	0.82	15.64
55.00	0.86	15.88
100.00	0.90	15.29
400.00	1.15	9.68
450.00	1.34	9.15
500.00	1.51	8.67

RF Transformer TC8-1

Typical Performance Curves

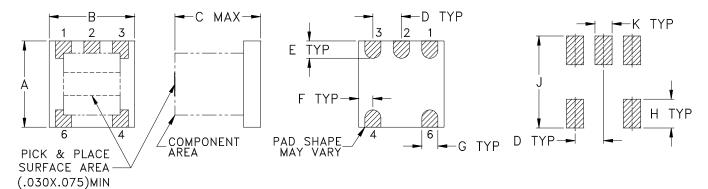




Outline Dimensions

AT224

PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	C	D	Е	F	G	Н	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)		.10

Dimensions are in inches (mm). Tolerances: 2 Pl. \pm .01; 3 Pl. \pm .005

Notes:

- 1. Open style, ceramic base.
- 2. Termination finish:

For RoHS Case Styles: 2-10 μ inch (.05-.25 microns) Gold over 100-300 μ inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



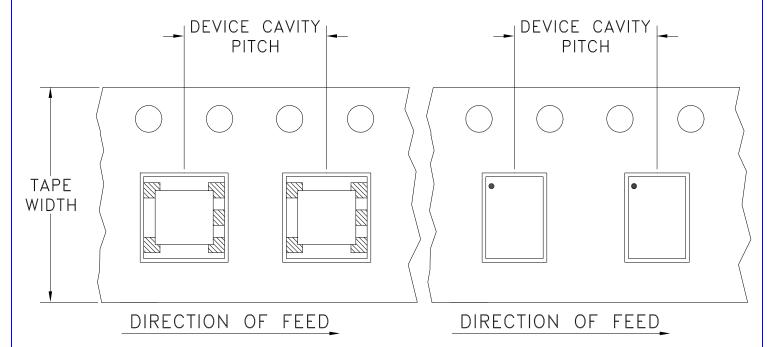


P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits we'b site

The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width,	Device Cavity	Reel Size,	Devices	s per Reel
mm	Pitch, mm	inches		
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		12	Ctandard	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

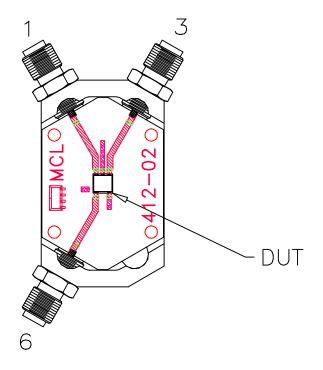
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com
RF/IF MICROWAVE COMPONENTS:

98-TR- Rev.: C (02/13/18) M166283 File: 98-TR-F17.docx

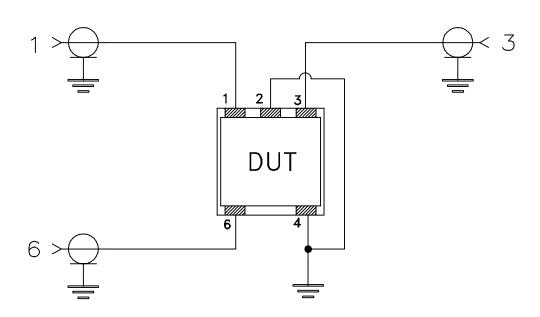
This document and its contents are the property of Mini-Circuits.

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

- 1. 50 Ohm SMA Female connectors.
- 2. PCB Material: Rogers RO4350B or its equivalent, III Mini-Circuits® Dielectric Constant=3.5, Thickness=.020"



Environmental Specifications

ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02 Rev: A

02/25/11

M130240 File: ENV02.pdf

This document and its contents are the property of Mini-Circuits.